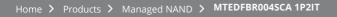




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MTEDFBR004SCA-1P2IT



ROHS CERTIFICATES

DOCUMENTATION & SUPPORT

PARTS WITH SHEET

ROHS CERTIFICATES

Data Sheets (1)



Embedded USB Mass Storage Drive (eU500)

eUSB, MTEDFAE0xxSCA, MTEDFAR0xxSCA, MTEDFBE0xxSCA, MTEDFBR0xxSCA

File Type: PDF

Updated: 01/2018

Embedded **Embedded USB** Managed NAND **SLC NAND**

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Specs

Orderable Parts for: MTEDFBR004SCA-1P2IT

	Status	Media	FBGA Code	SPD Data	Chipset Validation	PLP	Start Date	Alternative Part
MTEDFBR004SCA- 1P2IT	Production	N/A	N/A	N/A	N/A	No		N/A

Detailed Specifications

Density	4GB	Part Status	Production	Package	eUSB	Voltage	3.3V
Op Temp	-40C to +85C	Interface	USB 3.1	RoHS	Yes		

RoHS Certificates

RoHS Certificate of Compliance (PDF)

Part-specific certification of how this product meets the requirements of the current DIRECTIVE 2011/65/EU and 2015/863/EU, a.k.a. Restriction of Hazardous Substances (RoHS) Directive (Recast) without exemptions.

File Type: (PDF)

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RoHS Certificates

China RoHS Certificate (PDF)

Part-specific certification as required by China's Management Methods for Controlling Pollution by Electronic Information Products.

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Technical Notes

SEARCH (1) EMBEDDED USB TECHNICAL NOTES

Technical Notes

TN-FD-35: eU500 eUSB SMART Commands (PDF)

(TN-FD-35) This technical note provides the self-monitoring, analysis, and reporting technology (SMART) command (B0h) feature set for the Micron® eU500 embedded USB mass storage drive.

File Type: PDF

Updated: 09/12/2017

Embedded Embedded USB Managed NAND SLC NAND

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Product Marks, Product Labels, and Packaging Labels (PDF)

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Micron BGA Manufacturer's User Guide (PDF)

(CSN-33) Provides information to enable customers to easily integrate both leading-edge and legacy Micron's ball grid array (BGA) packages into their manufacturing processes. It is intended as a set of high-level guidelines and a reference manual describing typical package-related and...

File Type: PDF

Updated: 12/10/2014

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Parts with the same Data Sheet (7)

MTEDFBR004SCA-1P2IT (Current)		MTEDFAE004SCA-1P2	MTEDFAE004SCA-1P2IT	MTEDFBR008SCA-1P2IT	
Part Status Production		Production	Production	Production	
Density	4GB	4GB	4GB	8GB	
Package	eUSB	eUSB	eUSB	eUSB	
Voltage	3.3V	5V	5V	3.3V	
Op Temp	-40C to +85C	0C to +70C	-40C to +85C	-40C to +85C	
Interface	USB 3.1	USB 3.1	USB 3.1	USB 3.1	
RoHS	Yes	Yes	Yes	Yes	

MTEDFBR004SCA-1P2IT

(Current)

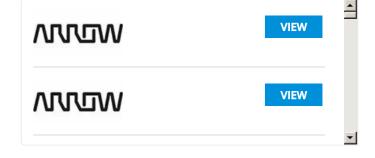
	Part Status	Production
	Density	4GB
	Package	eUSB
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